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NDS9948

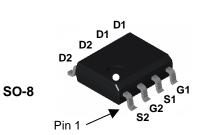
Dual 60V P-Channel PowerTrench[®] MOSFET

General Description

This P-Channel MOSFET is a rugged gate version of ON Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gate drive voltage ratings (4.5V - 20V).

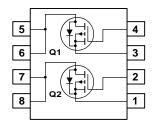
Applications

- Power management
- Load switch
- Battery protection



Features

- Low gate charge (9nC typical)
- Fast switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol		Parameter			Ratings	Units	
V _{DSS}	Drain-Sourc	e Voltage			-60	V	
V _{GSS}	Gate-Sourc	e Voltage			±20	V	
I _D	Drain Curre	nt – Continuous	(Note	1a)	-2.3	А	
		- Pulsed			-10		
P _D	Power Dissipation for Dual Operation				2	W	
	Power Dissipation for Single Operation			1a)	1.6		
			(Note	1b)	1.0		
			(Note	1c)	0.9		
T_J, T_{STG}	Operating a	ing and Storage Junction Temperature Range			-55 to +175	°C	
Therma	I Charac	teristics					
$R_{\theta JA}$	Thermal Re	sistance, Junction-to-Am	nbient (Note	1a)	78	°C/W	
			(Note ?	1c)	135	°C/W	
$R_{\theta JC}$	Thermal Re	Resistance, Junction-to-Case (Not		1)	40	°C/W	
Packag	e Markin	g and Ordering	Informat	ion			
•	Marking	Device	Reel Size		Tape width	Quantity	
NDS9948		NDS9948	13"		12mm	2500 units	

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Publication Order Number: NDS9948/D

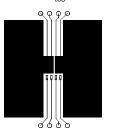
	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	burce Avalanche Ratings (Not	e 2)				
W _{DSS}	Drain-Source Avalanche Energy	Single Pulse, V _{DD} =–54 V			15	mJ
I _{AR}	Drain-Source Avalanche Current				-10	Α
Off Char	racteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-60			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-52		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -40 V$, $V_{GS} = 0 V$ $V_{DS} = -40 V$, $V_{GS} = 0 V T_J = -55^{\circ}C$			-2 -25	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
	Gate-Body Leakage, Reverse	$V_{GS} = -20 \text{ V} \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-1	-1.5	-3	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		4		mV/°0
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -10 \ V, I_D = -2.3 \ A \\ V_{GS} = -4.5 \ V, I_D = -1.6 \ A \\ V_{GS} = -10 \ V, I_D = -2.3 A, \ T_J = 125^\circ C \end{array} $		138 175 225	250 500 433	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$	-10			A
g fs	Forward Transconductance	$V_{DS} = -10 \text{ V}, \qquad I_D = -2.3 \text{ A}$		5		S
Dynamic	Characteristics	·				
C _{iss}	Input Capacitance	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V},$		394		pF
Coss	Output Capacitance	f = 1.0 MHz		53		pF
Crss	Reverse Transfer Capacitance	1		23		pF
Switchir	ng Characteristics (Note 2)	1				
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -30 V$, $I_D = -1 A$,		6	12	ns
t _r	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, R_{GEN} = 6 \Omega$		9	18	ns
t _{d(off)}	Turn–Off Delay Time	-		16	29	ns
t _f	Turn–Off Fall Time	-		3	6	ns
Q _g	Total Gate Charge	$V_{DS} = -30 \text{ V}, \qquad I_D = -2.3 \text{ A},$		9	13	nC
3	Gate–Source Charge	$V_{GS} = -10 \text{ V}$		1.4		nC
Q _{as}	Gate–Drain Charge	-		1.7		nC

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-S	ource Diode Characteristic	s and Maximum Ratings				
ls	Maximum Continuous Drain-Sour	rce Diode Forward Current			-1.7	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_{S} = -1.7 A(Note 2)$		-0.8	-1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V,$ $I_F = -2.3A,$ $dI_F/dt = 100A/\mu s$		25		nS

Notes:

1. R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.

b)



78°C/W when mounted on a 0.5in² pad of 2 oz copper

a)

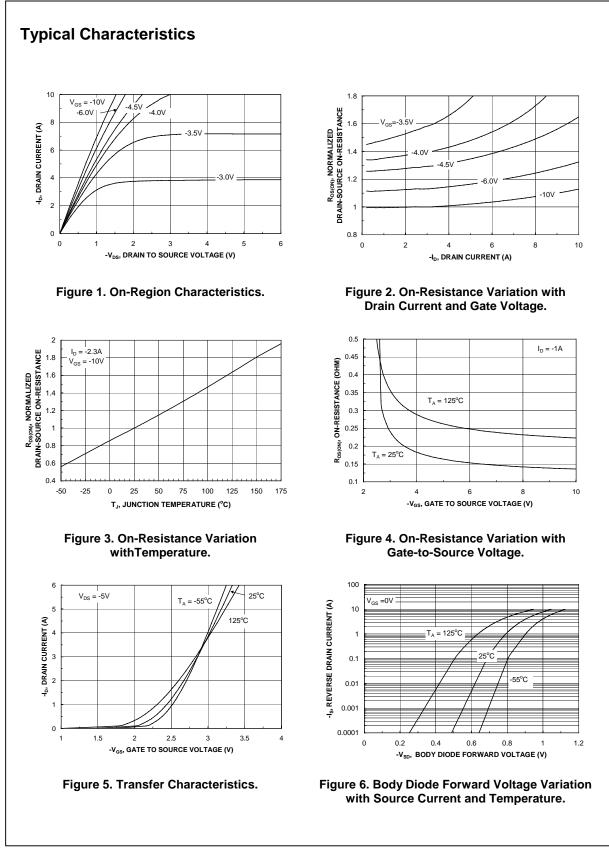


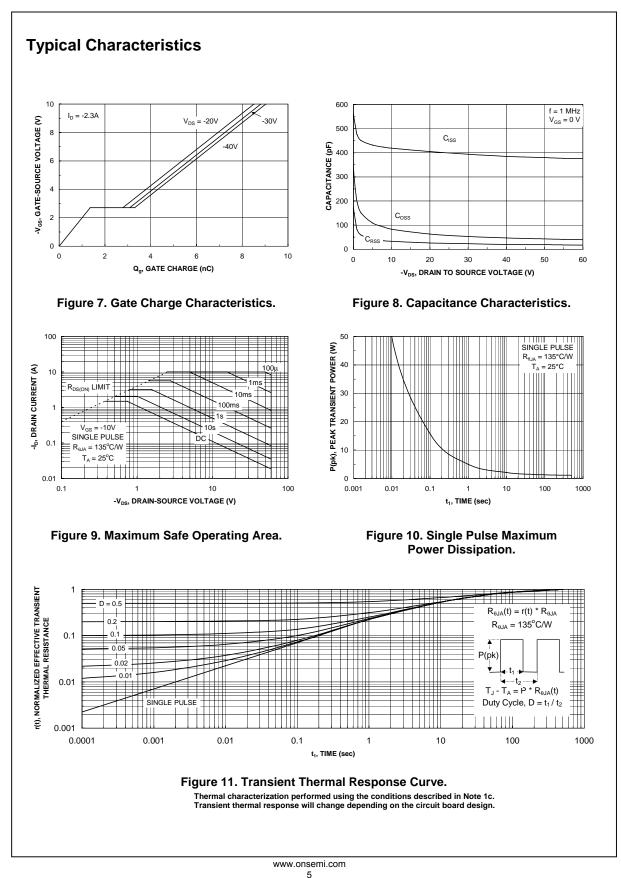
125°C/W when mounted on a 0.02 in² pad of 2 oz copper 0000 0000 0000

135°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%





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